

LISTING OF THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. **(Currently Amended)** A stacked coil device comprising:
 ~~at least two layers of~~ an inner electrode part ~~layer formed of at least two layers and~~ having
a non-magnetic electrode region ~~[[layer]]~~ and an inner magnetic ~~[[layer]]~~ region assembled as one
~~[[unit]] layer, said non-magnetic electrode region being provided with an opening at a center thereof~~
~~and with an electrode pattern on at least one of upper and lower surfaces thereof, and said inner~~
~~magnetic region being positioned at the opening and at lateral sides of the non-magnetic electrode~~
~~region;~~
 ~~a non-magnetic electrode layer provided with an opening at a center thereof and provided~~
~~with an electrode pattern on at least one surface of upper and lower surfaces thereof;~~
 ~~an inner magnetic layer positioned at the center opening and a lateral surface of the~~
~~non-magnetic electrode layer;~~
 a cover layer in contact with both surfaces of the inner electrode part ~~[[layer]]~~; and
 an external electrode terminal electrically connected to a part of the electrode pattern.
2. **(Currently Amended)** The device of claim 1, wherein a first via hole is formed
on the non-magnetic electrode region ~~[[layer]]~~ at a part where the electrode pattern is not formed,
a second via hole is formed on the electrode pattern, and a conductive material is filled in the via
holes.
3. **(Currently Amended)** The device of claim 2, wherein a part of the electrode
pattern of the non-magnetic electrode region ~~[[layer]]~~ where the via holes are formed is electrically
connected to electrode patterns of another non-magnetic electrode region ~~[[layers]]~~ in contact with
upper and lower surfaces of the non-magnetic electrode region ~~[[layer]]~~ through the via holes.
4. **(Currently Amended)** The device of claim 1, wherein the cover layer further
includes an inner electrode layer ~~a non-magnetic layer~~.

5. **(Original)** The device of claim 1, further comprising a buffer layer composed of a non-magnetic layer or a magnetic layer having the same shape as the inner electrode layer and having no electrode pattern between the cover layer and the inner electrode layer.

6. **(Currently Amended)** The device of claim 1, wherein the non-magnetic electrode region ~~[[layer]]~~ is composed of B_2O_3 - SiO_2 based glass, Al_2O_3 - SiO_2 based glass, or ceramic material having similar thermal expansion ratio to the ferrite.

7. **(Currently Amended)** The device of claim 1, wherein the inner magnetic region ~~[[layer]]~~ is composed of ferrite such as Ni-based material, Ni-Zn based material, Ni-Zn-Cu based material, and etc.

8. **(Currently Amended)** A fabrication method of a stacked coil device comprising:
preparing a magnetic film green sheet ~~[[sheets]]~~ that a magnetic film is ~~and a non-magnetic film are respectively~~ formed on a carrier film and a non-magnetic film green sheet that a non-magnetic film is formed on a carrier film;

forming cutting lines on the magnetic film green sheet and forming an opening in the non-magnetic film green sheet;

forming via holes on the non-magnetic film green sheet ~~where the cutting lines are formed~~;

forming an electrode pattern at an upper surface of the non-magnetic film green sheet ~~where the via holes are formed~~;

picking up unnecessary parts from the magnetic film green sheet and the non-magnetic film green sheet;

stacking the green sheet where the magnetic film and the cutting lines are formed, and the green sheet where the non-magnetic film, the opening cutting lines, the via holes, and the electrode pattern are formed wherein pick-up regions of the magnetic film green sheet and the non-magnetic film green sheet are opposite to each other thus to constitute one single layer of a magnetic region and a non-magnetic region;

firing the ~~[[stack]]~~ stacked body; and

forming an external electrode terminal at an outer surface of the fired stack body.

9. **(Original)** The method of claim 8, wherein the magnetic green sheet or the non-magnetic green sheet on the carrier film are respectively formed by using a doctor blade tape casting method.

10. **(Canceled)**

11. **(Currently Amended)** The method of claim 8, wherein the electrode pattern of an upper surface of the non-magnetic region ~~film-green-sheet~~ is formed by a screen printing.

12. **(Canceled)**